



Certificate of Registration

This certifies that the Quality Management System of

Integra Technologies Silicon Valley, LLC

1804 McCarthy Boulevard
Milpitas, California, 95035, United States

has been assessed by NSF-ISR and found to be in conformance to the following standard(s):

ISO 13485: 2016

Scope of Certification:

Die Preparation for Wafer Sort, Thinning, UV Expose, Dicing, Polish, Plate, Inspection and Assembly Services for Die Attach, Wire Bond, Seal, Flip Chip, Mold, Ball Attach, Environment Testing, Marking, Laser Marking, X- Ray, CSAM, Tape & Reel, Electrical Testing, Burn in, Reliability, Packing, EOL.

Sameer Vachani
Senior Director, NSF-ISR

Certificate Number:	C0171872-MD13
Certificate Decision Date:	26-AUG-2026
Certificate Issue Date:	26-AUG-2026
Cycle Effective Date:	21-APR-2026
Certificate Expiration Date*:	20-APR-2029

Issued by:

NSF International Strategic Registrations (NSF-ISR)
789 N. Dixboro Road, Ann Arbor, MI 48105 USA

Authorized Certification and/or Accreditation Marks. This certificate is property of NSF-ISR and must be returned upon request.

*Company is audited for conformance at regular intervals. To verify certification call (888) NSF-9000 or visit our web site at www.nsf-isr.org





Certificate of Registration

ANNEX PAGE FOR CERTIFICATE NUMBER: C0171872-MD13

This Annex is only Valid in connection with the above-mentioned certificate issued by NSF-ISR

CERTIFICATE ISSUE DATE:

26-AUG-2026

CERTIFICATE EXPIRATION DATE:

20-APR-2029

Integra Technologies Silicon Valley, LLC
1804 McCarthy Boulevard
Milpitas, California, 95035, United States

Location:

Integra Technologies Silicon Valley,
LLC- C0901256
1635 McCarthy Boulevard
Milpitas, California, 95035, United
States

Scope:

This location is part of site C0171872. Supporting processes include: Die Preparation for Wafer Sort, Thinning, UV Expose, Dicing, Polish, Plate, Inspection and Assembly Services for Die Attach, Wire Bond, Seal, Flip Chip, Mold, Ball Attach, Environment Testing, Marking, Laser Marking, X- Ray, CSAM, Tape & Reel, Electrical Testing, Burn in, Reliability, Packing, EOL.

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